

C1808C331KFRAC7210

SMD Comm X7R HV, Ceramic, 330 pF, 10%, 1,500 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1808, 2.9 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	100 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		1
Chip Size	1808	(
L	4.7mm +/-0.5mm	1
W	2mm +/-0.2mm	
т	1.6mm +/-0.15mm	,
S	2.9mm MIN	I
В	0.6mm +/-0.35mm	
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Packaging Specifications Packaging

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

Specifications	
Capacitance	330 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1500 VDC
Dielectric Withstanding Voltage	1,800 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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